

The ST1002 use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics. This device is specially designed to get better ruggedness and suitable to use in

### **General Features**

V<sub>DS</sub> =100V I<sub>D</sub> =5 A

 $R_{DS(ON)}$  < 140m $\Omega$ @ V<sub>GS</sub>=10V

### Applications

Consumer electronic power supply Motor control

Synchronous-rectification Isolated DC

Synchronous-rectification applications

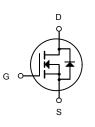
#### Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
ST1002	SOT-23-3L	HXY MOSFET	3000

#### Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units	
Vds	Drain-Source Voltage 100		V	
Vgs	Gate-Source Voltage	±20	V	
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	5	A	
I <sub>D</sub> @T <sub>C</sub> =70 °C	Continuous Drain Current, V <sub>GS</sub> @ 10V	2.2	A	
Ідм	Pulsed Drain Current <sup>2</sup>	11	A	
P <b></b> @Tc=25°C	Total Power Dissipation <sup>4</sup>	1	W	
Тѕтс	Storage Temperature Range -55 to 150		°C	
TJ	Operating Junction Temperature Range -55 to 150		°C	
R₀JC	Thermal Resistance from Junction-to-Ambient <sup>3</sup> 80 °C		°C/W	
Reja	Thermal Resistance Junction-Ambient <sup>1</sup> 125   °C		°C/W	





N-Channel MOSFET



## Electrical Characteristics Tc=25°C unless otherwise specified

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Chara	cteristic			•		
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	100	110	-	V
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V	-	-	1	μA
Igss	Gate to Body Leakage Current	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V	-	-	±100	nA
On Charac	cteristics <sup>note3</sup>					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0	1.95	3.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance note2	V <sub>GS</sub> = 10V, I <sub>D</sub> = 3A	-	95	140	mΩ
Dynamic (	Characteristics note4					
Ciss	Input Capacitance	$V_{DS} = 50V, V_{GS} = 0V,$	-	196	-	pF
Coss	Output Capacitance		-	25.9	-	pF
Crss	Reverse Transfer Capacitance	f = 1.0MHz	-	21.4	-	pF
Qg	Total Gate Charge	V <sub>DS</sub> = 50V, I <sub>D</sub> = 3A, V <sub>GS</sub> = 10V	-	4.3	-	nC
Qgs	Gate-Source Charge		-	3.5	-	nC
Q <sub>gd</sub>	Gate-Drain("Miller") Charge	$V_{GS} = 10V$	-	3.1	-	nC
Switching	Characteristics note4					
t <sub>d(on)</sub>	Turn-On Delay Time		-	14.7	-	ns
tr	Turn-On Rise Time	V <sub>DD</sub> = 50V, I <sub>DS</sub> =3A		3.5	-	ns
$t_{d(off)}$	Turn-Off Delay Time	$R_G = 2\Omega, V_{GEN} = 10V$	-	20.9	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	2.7	-	ns
Drain-Sou	irce Diode Characteristics and Maximum Rati	ngs		•		
ls	s Maximum Continuous Drain to Source Diode Forward Current <sup>note2</sup>		-	-	4.5	А
Ism	Maximum Pulsed Drain to Source Diode Forward Current		-	-	12	А
V <sub>SD</sub>	Drain to Source Diode Forward Voltage note3 V <sub>GS</sub> = 0V, I <sub>S</sub> = 3A		-	-	1.3	V
trr	Body Diode Reverse Recovery Time		-	32.1	-	ns
Qrr	Body Diode Reverse Recovery Time Charge	$V_{\rm GS} = 0V, I_{\rm F} = 3A,$	-	39.4	-	nC
Irrm	Peak Reverse Recovery Current	di/dt =100A/µs	-	2.1	-	А

Notes:

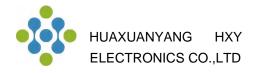
1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t  $\leq$  10 sec.

3. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$ 2%.

4. Guaranteed by design, not subject to production

5. V\_DD=50 V, R\_G=50  $\Omega,$  L=0.3 mH, starting T\_j=25  $^\circ\text{C}$ 



### **Typical Characteristics**

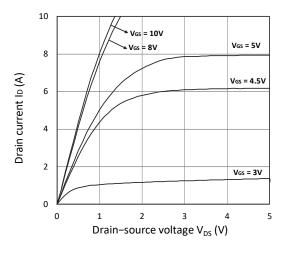


Figure 1. Output Characteristics

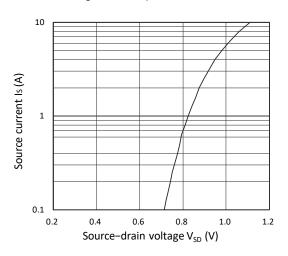


Figure 3. Forward Characteristics of Reverse

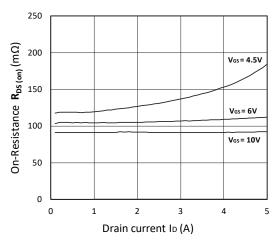


Figure 5.  $R_{DS(ON)}$  vs.  $I_D$ 

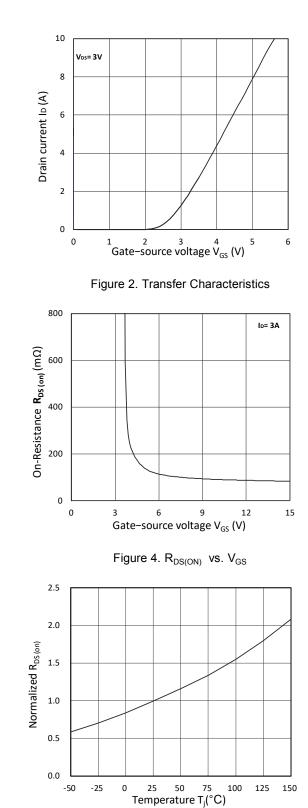


Figure 6. Normalized  $R_{DS(on)}$  vs. Temperature



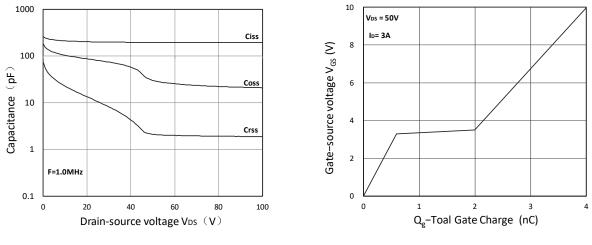
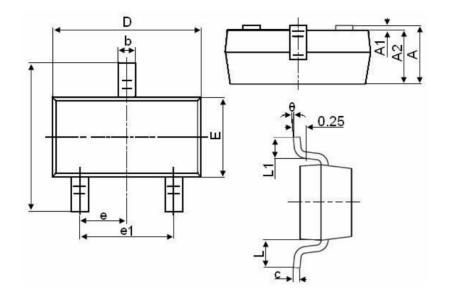


Figure 7. Capacitance Characteristics

Figure 8. Gate Charge Characteristics



## SOT-23-3L Package Information



Symbol	Dimensions in Millimeters		
	MIN.	MAX.	
A	1.050	1.250	
A1	0.000	0.100	
A2	1.050	1.150	
b	0.300	0.500	
с	0.100	0.200	
D	2.800	3.000	
E	1.500	1.700	
E1	2.650	2.950	
е		0.950TYP	
e1	1.800	2.000	
L	0.550REF		
L1	0.300	0.600	
θ	0°	8°	



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